

# RILSAN®

## BZM 8 O TL

PA11, MHLR, 18-030, GF8

**Rilsan® BZM 8 O TL** is a fiberglass reinforced polyamide 11 produced from a renewable source. This natural grade is designed for injection.

PROPERTIES	DRY / COND	UNIT	TEST STANDARD
<b>RHEOLOGICAL PROPERTIES</b>			
Melt Volume-Flow Rate	18 / *	cm <sup>3</sup> /10 min	ISO 1133
Temperature	235 / *	°C	-
	455 / *	°F	-
Load	5 / *	kg	-
	11 / *	lb	-
Molding Shrinkage, parallel	1.1 / *	%	ISO 294-4, 2577
Molding Shrinkage, normal	0.9 / *	%	ISO 294-4, 2577
<b>MECHANICAL PROPERTIES</b>			
Tensile Modulus	- / 2300	MPa	ISO 527-1/-2
	- / 334000	psi	
Stress at Break	- / 56	MPa	ISO 527-1/-2
	- / 8120	psi	
Strain at Break	- / 26	%	ISO 527-1/-2
Shore D Hardness, after 15 s	73 / *	-	ISO 868
Charpy Impact Strength, +23°C	- / 93	kJ/m <sup>2</sup>	ISO 179/1eU
	- / 44.2	ftlb/in <sup>2</sup>	
Charpy Impact Strength, -30°C	- / 88	kJ/m <sup>2</sup>	ISO 179/1eU
	- / 41.9	ftlb/in <sup>2</sup>	
Charpy Notched Impact Strength, +23°C	- / 10	kJ/m <sup>2</sup>	ISO 179/1eA
	- / 4.76	ftlb/in <sup>2</sup>	
Charpy Notched Impact Strength, -30°C	- / 5	kJ/m <sup>2</sup>	ISO 179/1eA
	- / 2.38	ftlb/in <sup>2</sup>	
<b>THERMAL PROPERTIES</b>			
Melting Temperature, 10°C/min	189 / *	°C	ISO 11357-1/-3
Coeff. of Linear Thermal Expansion, parallel	60 / *	E-6/K	ISO 11359-1/-2
Burning Behav. at 1.5 mm Nominal Thickness	HB / *	class	IEC 60695-11-10
Thickness Tested	1.6 / *	mm	-
	0.0630 / *	in	-

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Source: automatically generated TDS from Material Database on 20-02-2024

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Burning Behav. at Thickness h	HB / *	class	IEC 60695-11-10
Thickness Tested	3.2 / *	mm	-
	0.1260 / *	in	
Oxygen Index	22 / *	%	ISO 4589-1/-2
OTHER PROPERTIES			
Density	1070 / 1070	kg/m <sup>3</sup>	ISO 1183
	1.07 / 1.07	g/cm <sup>3</sup>	

### MAIN APPLICATIONS:

- Spring for quick connectors
- Outsoles

### PACKAGING:

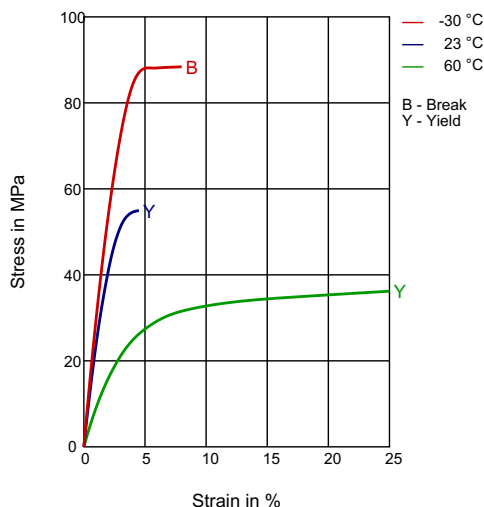
This grade is delivered dried in sealed packaging (25 kg bags) ready to be processed.

### SHELF LIFE:

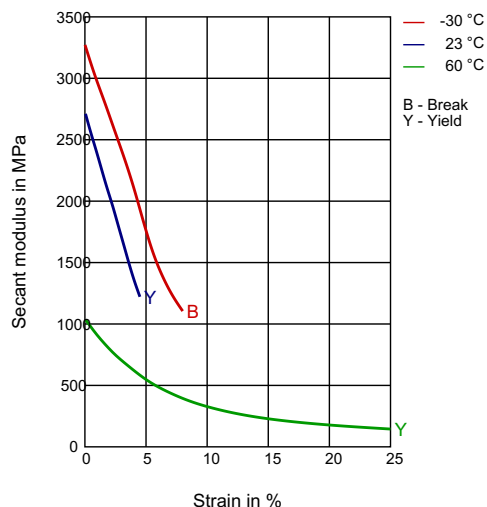
Two years from the delivery. For any use above this limit, please refer to our technical services.

### DIAGRAMS

#### STRESS-STRAIN



#### SECANT MODULUS-STRAIN



### Processing conditions:

- Typical melt temperature (Min / Recommended / Max) : 250°C / 270°C / 290°C.
- Mold temperature : 40 - 90°C
- Drying time and temperature (only necessary for bags opened for more than two hours) : 4-6 hours at 80-90°C.

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<b>PROCESSING</b> Injection Molding	<b>Headquarters:</b> Arkema France 420 rue d'Estienne d'Orves 92705 Colombes Cedex France T +33 (0)1 49 00 80 80 hpp.arkema.com  Arkema Inc. – High Performance Polymers 900 First Avenue King of Prussia, PA 19406 Tel.: +1 610 205 7000 hpp.arkema.com
<b>DELIVERY FORM</b> Pellets	
<b>ADDITIVES</b> Release agent	
<b>SPECIAL CHARACTERISTICS</b> Bio-Based, Heat Stabilized, Light Stabilized	
<b>REGIONAL AVAILABILITY</b> North America, Europe, Asia Pacific, South and Central America, Near East/Africa	

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